

03-14-2006



103196008

EET

PG

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

3400

1. Name of conveying party(ies)

Brian W. Condie
Lakshminarayan Viswanathan
Richard W. Wetz

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: Freescale Semiconductor, Inc.

Internal Address: TX32/PL02

Street Address: 7700 W. Parmer Lane

City: Austin

State: Texas

Country: U.S.A. Zip: 78729

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) October 21, 2005

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

11/257,783

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: George C. Chen

Internal Address: Suite 2200

Street Address: Two North Central Avenue

City: Phoenix

State: Arizona Zip: 85004-4406

Phone Number: (602) 364-7367

Fax Number: (602) 364-7070

Email Address: gcchen@bryancave.com

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
- Enclosed
- None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers _____
Expiration Date _____

b. Deposit Account Number 02-4467

Authorized User Name Bryan Cave LLP

9. Signature:

Signature

March 8, 2006

Date

George C. Chen

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

4



George C. Chen
Registered Patent Attorney
Voice: 602-364-7367
GCCHEN@BRYANCAVE.COM

10-24-05

11-01-2005



103110987

October 24, 2005

VIA U.S. MAIL

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Re: New U.S. Utility Patent Application
Inventors: Condie et al.
Title: Semiconductor Structure and Method of Manufacture
Attorney Docket No.: 0190975

Dear Sir/Madam:

Enclosed herewith for filing in the above-identified application are the following:

1. Transmittal Letter (2 pgs.);
2. Specification (29 pgs.);
3. Formal Drawings (6 pgs.);
4. New Application Transmittal (5 pgs.);
5. Information Disclosure Statement (3 pgs.), and copies of cited references;
6. Assignment (3 pgs.);
7. Declaration (3 pgs.);
8. Check no. 1483 in the amount of \$1,590.00; and
9. Self-addressed, prepaid postcard to acknowledge receipt of documents.

Very truly yours,

George C. Chen
GCC/da
Enclosures

PX01DOCS\524046.1

113260 U.S. PTO
11/257783
102405

Bryan Cave LLP
One Renaissance Square
Two North Central Avenue
Suite 2200
Phoenix, AZ 85004-4406
Tel (602) 364-7000
Fax (602) 364-7070
www.bryancave.com

Chicago
Hong Kong
Irvine
Jefferson City
Kansas City
Kuwait
Los Angeles
New York
Phoenix
Riyadh
Shanghai
St. Louis
United Arab Emirates (Dubai)
Washington, DC

And Bryan Cave,
A Multinational Partnership,
London

10/27/2005 SFELEKE1 00000048 11257783
40.00 0P
06 FC:8021

ASSIGNMENT

In consideration of our agreement with Freescale Semiconductor, Inc., and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, Brian W. Condie, an individual residing in Mesa, Arizona, I, Lakshminarayan Viswanathan, an individual residing in Phoenix, Arizona, and I, Richard W. Wetz, an individual residing in Chandler, Arizona, hereby assign, transfer, set over, convey, and deliver to Freescale Semiconductor, Inc., a Texas corporation, having a principal place of business located at 7700 W. Parmer Lane, TX32/PL02, Austin, Texas 78729, its successors and assigns (collectively referred to herein as "ASSIGNEE") all our rights, title, and interest in, to, and under any and all subject matter of the invention(s) disclosed and/or claimed in the application for United States patent, titled

SEMICONDUCTOR STRUCTURE AND METHOD OF MANUFACTURE

filed in the U.S. Patent and Trademark Office herewith; in, to, and under the said application and any and all provisional, continuation, continuation-in-part, continued prosecution, request-for-continued-examination, and divisional applications thereof; in, to, and under, my exclusive right to make and prosecute any and all applications for patents, reissues, renewals, and extensions thereof; in, to, and under any and all patents and Convention and Treaty rights of all kinds, in the United States of America and all other countries throughout the world, for all such subject matter; in, to, and under any and all know-how and/or confidential, proprietary, and/or trade secret information relating to any such subject matter, applications, patents, and/or technology; in, to, and under the right to sue for present, past, and future infringement or misappropriation relating to any such subject matter, applications, patents, and/or technology; in, to, and under the right to enforce any rights and file any causes of action, in law and/or equity, relating to any such subject matter, applications, patents, and/or technology; and in, to, and under the right to all income, royalties, fees, damages, and payments now or hereafter due or payable in respect to any such subject matter, applications, patents, and/or technology. The right, title, and interest is to be held and enjoyed by ASSIGNEE and its successors and assigns as fully and exclusively as it would have been held and enjoyed by ASSIGNOR had this assignment not been made. We request the applicable official having authority to issue patents and/or corresponding rights to issue same on the subject matter of the said invention(s) to ASSIGNEE, its successors and assigns, and, if called upon by ASSIGNEE, its successors, assigns, or legal representatives, we agree to promptly sign any and all documents necessary to secure any and all such patents and/or rights and for issuance of same to ASSIGNEE or its successors and assigns.

We covenant with ASSIGNEE, its successors, assigns, and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license, or other encumbrance.

We grant to ASSIGNEE, its successors, assigns, and legal representatives the power to insert on this assignment any further identification, including the application number and filing dates, which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

530586.1

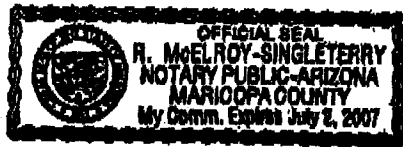
1

Date: 10/21/05

L. Viswanathan
Lakshminarayan Viswanathan

STATE OF Arizona :
COUNTY OF Maricopa : SS

On this 21 day of October, 2005, Lakshminarayan Viswanathan personally appeared before me, identified himself to my satisfaction, and signed the foregoing Assignment in my presence.



R. McElroy-Singleterry
Notary Public

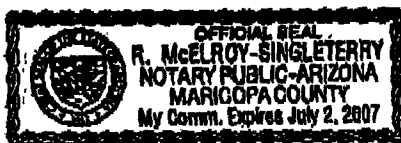
My commission expires: 7/2/07

Date: 10/21/05

Richard W. Wetz
Richard W. Wetz

STATE OF Arizona :
COUNTY OF Maricopa : SS

On this 21 day of October, 2005, Richard W. Wetz personally appeared before me, identified himself to my satisfaction, and signed the foregoing Assignment in my presence.



R. McElroy-Singleterry
Notary Public

My commission expires: 7/2/07